

Lecture 18

RF MEMS (6)

■ Agenda:

- ↗ MEMS Varactors: Survey
- ↗ MEMS Inductors: Survey

Most figures and data in this lecture, unless cited otherwise, were taken from RF MEMS Theory, Design and Technology by G. Rebeiz.

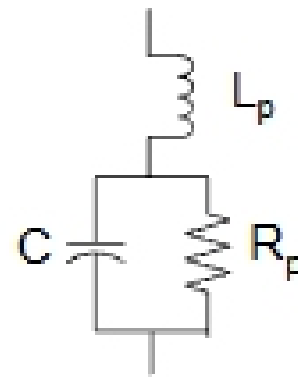
MEMS Varactors

□ Solid-state varactors

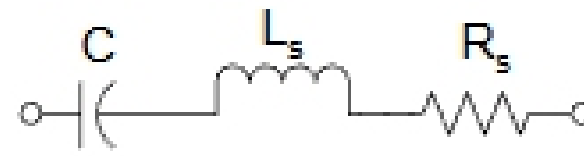
- ↗ Si, GaAs, SiGe
- ↗ Q: 30-60
- ↗ Capacitance ratio 4-6

□ MEMS Varactors

- ↗ High Q: >100
- ↗ Low cost
- ↗ Small capacitance ratio: 1.2-2.5
- ↗ Small capacitance (not suitable for below 1 GHz)



Parallel model



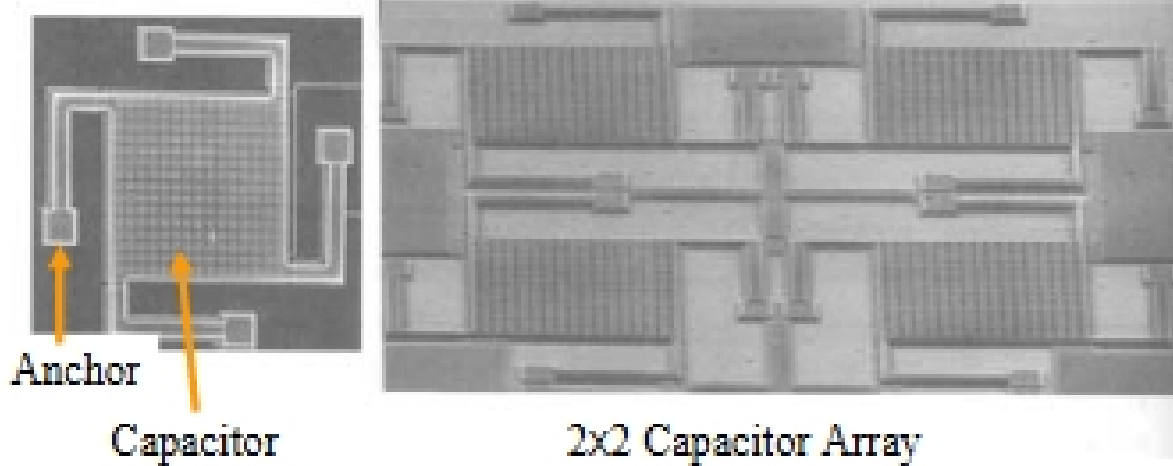
Series model

$$Q = \omega \frac{\text{average energy stored}}{\text{energy loss/second}}$$

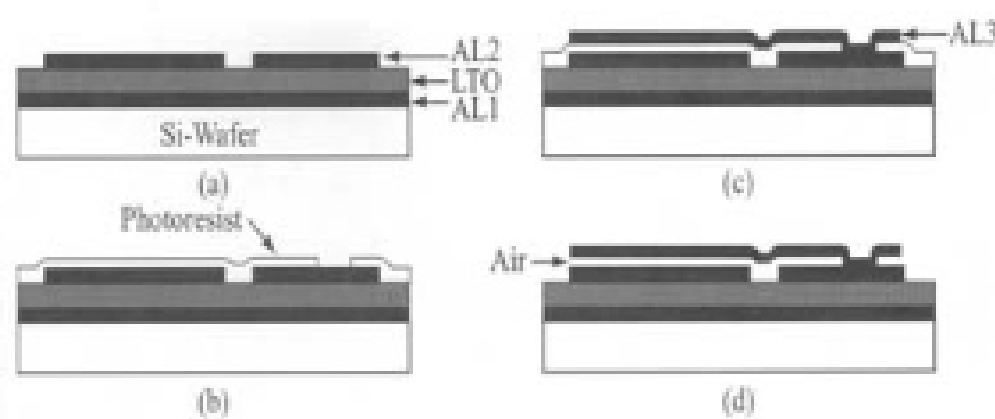
$$Q = \frac{|\text{Im}(Z)|}{\text{Re}(Z)} = \begin{cases} \frac{1}{\omega R_s C} & \text{For a series model} \\ \omega R_p C & \text{For a parallel model} \end{cases}$$

- Electrostatic Parallel-plate Varactors
- Tunable Interdigitated Capacitors
- Thermal Varactors
- Piezoelectric Parallel-plate Varactors
- MEMS Switched Capacitors
- MEMS Varactors with Discrete Values

Parallel-plate Varactor

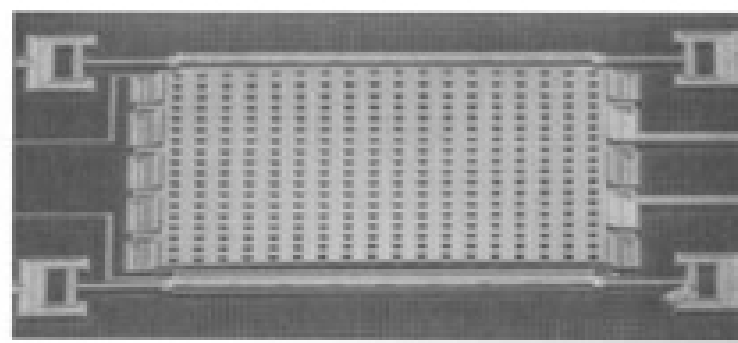


Young and Boser
(UC-Berkeley)
Hilton Head 1996

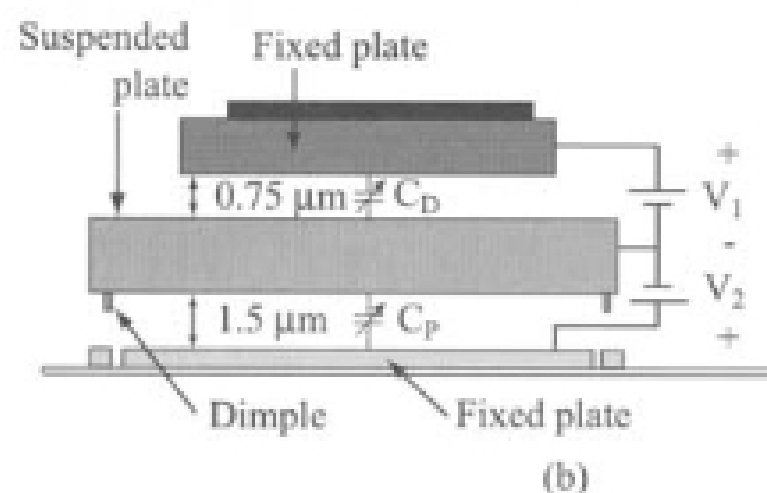


- Al plates
- 1.5 μm gap
- 15% capacitance change at 3V, limited by parasitics
- Q = 60 at 1GHz
- Low-temperature process
- CMOS-compatible

Three-plate Varactor



- Fabricated using poly-Si MUMPs
- 0.75/1.5 μm gaps
- Tuning range 3.4pF – 6.4pF at 4.5V
- Q = 16 at 1GHz



- Gold 0.5 μm
- Poly 2 1.5 μm
- Poly 1: 2.0 μm
- Poly 0: 0.5 μm
- Anchor

Dec and Suyama (Columbia University)
IEEE Trans. MTT, 2000